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April 2000

FQA16N50

500V N-Channel MOSFET

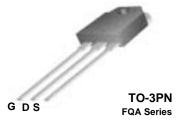
General Description

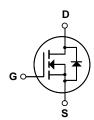
These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supply, power factor correction, electronic lamp ballast based on half bridge.

Features

- 16A, 500V, $R_{DS(on)}$ = 0.32 Ω @V_{GS} = 10 V Low gate charge (typical 60 nC)
- Low Crss (typical 35 pF)
- · Fast switching
- 100% avalanche tested
- · Improved dv/dt capability





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQA16N50	Units	
V _{DSS}	Drain-Source Voltage		500	V	
I _D	Drain Current - Continuous (T _C = 25	5°C)	16	А	
	- Continuous (T _C = 10	00°C)	10	А	
I _{DM}	Drain Current - Pulsed	(Note 1)	64	Α	
V_{GSS}	Gate-Source Voltage		± 30	V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	980	mJ	
I _{AR}	Avalanche Current	(Note 1)	16	А	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	20	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns	
P _D	Power Dissipation (T _C = 25°C)		200	W	
	- Derate above 25°C		1.59	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.63	°C/W
R _{θCS}	Thermal Resistance, Case-to-Sink	0.24		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		40	°C/W

Symbol	Parameter	Test Conditions		Min	Тур	Max	Units
Off Cha	aracteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		500			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to	o 25°C		0.53		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 500 V, V _{GS} = 0 V			-	1	μΑ
		V _{DS} = 400 V, T _C = 125°C				10	μА
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V				100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V				-100	nA
On Cha	racteristics						
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 8.0 A			0.25	0.32	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 50 V, I _D = 8.0 A	(Note 4)		14	-	S
C _{iss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz			2300 325 35	3000 420 45	pF pF
Crss					33	45	рг
	ing Characteristics				45	100	
t _{d(on)}	Turn-On Delay Time Turn-On Rise Time	$V_{DD} = 250 \text{ V}, I_D = 16 \text{ A},$ $R_G = 25 \Omega$ (Note 4, 5)			45 180	100 370	ns
t _r	Turn-Off Delay Time				130	270	ns ns
t _f	Turn-Off Fall Time				100	210	ns
Qg	Total Gate Charge	\/ - 400 \/ I - 16 A			60	75	nC
Q _{gs}	Gate-Source Charge	$V_{DS} = 400 \text{ V}, I_{D} = 16 \text{ A},$ $V_{GS} = 10 \text{ V}$			14		nC
Q _{qd}	Gate-Drain Charge	(Note 4, 5)			28		nC
	· · · · · · · · · · · · · · · · · · ·	M i					
ار Drain-S	Source Diode Characteristics and Maximum Ratings Maximum Continuous Drain-Source Diode Forward Current					16	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				64	Α	
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 16 A				1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 16 A,			340		ns
11	The residence of the second states	1 63 - 1, 13 1 - 1 .,					

- **Notes:**1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 6.9mH, I_{AS} = 16A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C 3. I_{SD} \leq 16A, di/dt \leq 2004/μs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C 4. Pulse Test : Pulse width \leq 300μs, Duty cycle \leq 2% 5. Essentially independent of operating temperature

Typical Characteristics

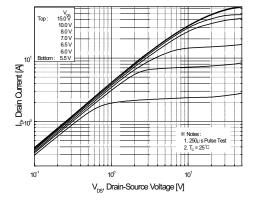


Figure 1. On-Region Characteristics

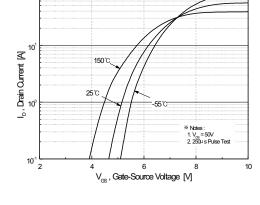


Figure 2. Transfer Characteristics

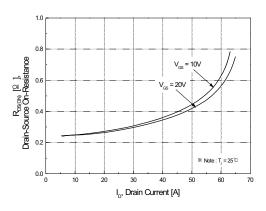


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

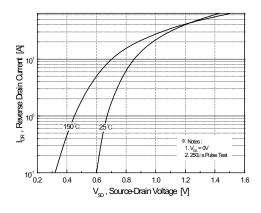


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

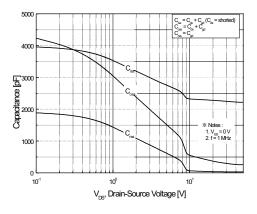


Figure 5. Capacitance Characteristics

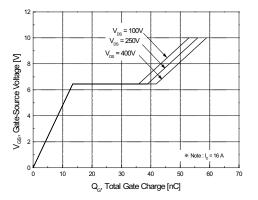


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

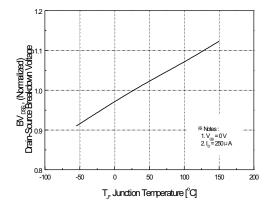


Figure 7. Breakdown Voltage Variation vs. Temperature

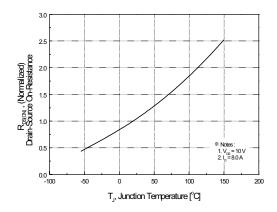


Figure 8. On-Resistance Variation vs. Temperature

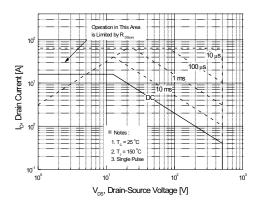


Figure 9. Maximum Safe Operating Area

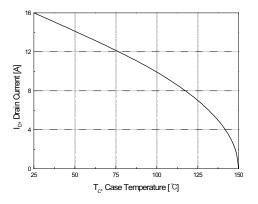


Figure 10. Maximum Drain Current vs. Case Temperature

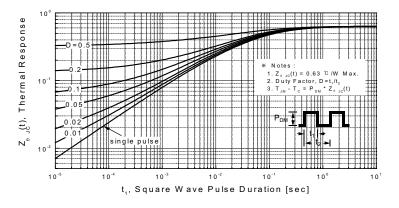
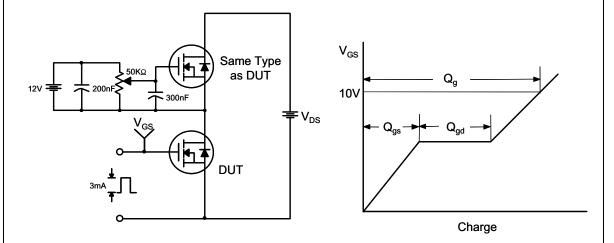


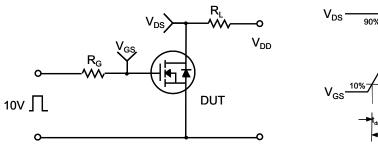
Figure 11. Transient Thermal Response Curve

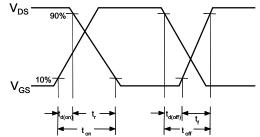
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Gate Charge Test Circuit & Waveform

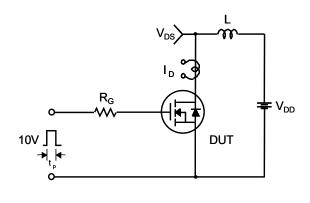


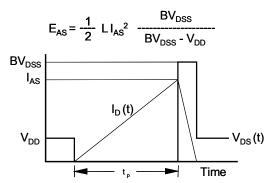
Resistive Switching Test Circuit & Waveforms



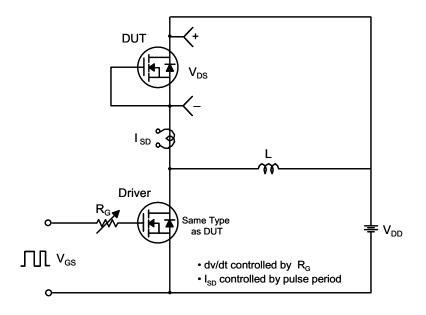


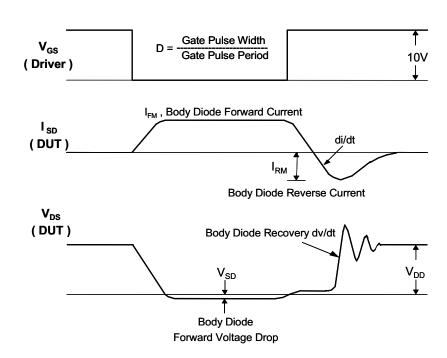
Unclamped Inductive Switching Test Circuit & Waveforms





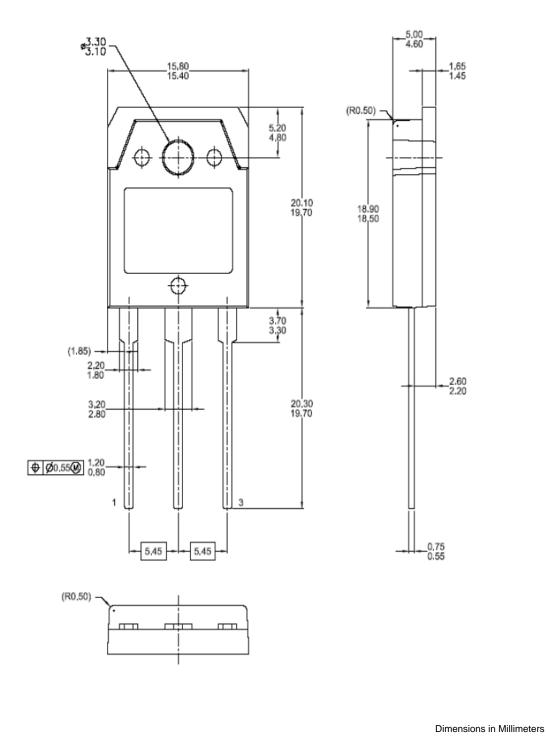
Peak Diode Recovery dv/dt Test Circuit & Waveforms





Mechanical Dimensions

TO-3PN



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